

Organic or Silicon TFT Device SPICE Modeling Service Questionnaire

Please fill out the following questionnaire. The data you provide in this form is necessary for Silvaco to supply you with high quality SPICE models.

Contact Person in Your Company

(for technical questions)

NAME: _____

COMPANY: _____

PHONE: _____

FAX: _____

EMAIL: _____

Package Part or Wafer Information:

For packaged parts please specify package type:

For wafer, please specify:

How many wafers will be supplied?: _____

Wafer #: _____

Lot#: _____

Are the devices in a scribeline or in a drop-in test die?:

Model Type

Please specify the SPICE model type (For example: Poly TFT, Amorphous TFT etc.)

Please specify the circuit simulator (including the version number) for which the models are generated.

Bias Conditions

Please specify the maximum bias conditions to apply for MODELING purposes. (Make sure the specified bias conditions are not destructive for the shortest channel length device over the temperature.

	NTYPE	PTYPE
Max VDS:	_____	_____
Max VGS:	_____	_____

Please include measured data plots of IDS/VDSmax, IDS/VGS @ VDS steps from 0V to VDSmax.

Temperature Conditions

Please specify the temperature points for devices to be characterized?

(For example: 0 C, 27 C, 85 C):

Process and Layout Related Information

Please provide the following information for the supplied wafer or the packaged parts.

	NTYPE	PTYPE
TOX:	_____	_____
VTO:	_____	_____

Test Chip Information

Please list the TFT devices in the test chip. (If there are more than 10 devices please specify only 10 critical devices.):

	NTYPE (μm)		PTYPE (μm)	
	W	L	W	L
1)	_____	_____	_____	_____
2)	_____	_____	_____	_____
3)	_____	_____	_____	_____
4)	_____	_____	_____	_____
5)	_____	_____	_____	_____
6)	_____	_____	_____	_____
7)	_____	_____	_____	_____
8)	_____	_____	_____	_____
9)	_____	_____	_____	_____
10)	_____	_____	_____	_____

Are these devices Poly TFT or Amorphous TFT or Organic?

Are there structures to measure overlap capacitances?
(If yes, please indicate the location of these structures on the test chip.)

Is there a Ring Oscillator circuit available for AC model validation? (If yes, please indicate the location of these structures on the test chip.)

Worst Case Corner Information

Please provide the following information for the worst case corner model generation: If the exact numbers are not available please enter the variation in percentage. If data is not available enter: N/A.

	NTYPE			PTYPE		
	min.	typ.	max	min.	typ.	max
TOX	_____	_____	_____	_____	_____	_____
VTO	_____	_____	_____	_____	_____	_____
W/L	_____	_____	_____	_____	_____	_____
CGDO	_____	_____	_____	_____	_____	_____
CGSO	_____	_____	_____	_____	_____	_____

Please add more parameters' variations UO (mobility, etc.) if available.

If you have any questions please contact:

SPICE Modeling Group
email: spicemodeling@silvaco.com

SILVACO

HEADQUARTERS

4701 Patrick Henry Drive, Bldg. 2
Santa Clara, CA 95054 USA
Phone: 408-567-1000
Fax: 408-496-6080

CALIFORNIA

sales@silvaco.com
408-567-1000

MASSACHUSETTS

masales@silvaco.com
978-323-7901

TEXAS

txsales@silvaco.com
512-418-2929

JAPAN

jpsales@silvaco.com

EUROPE

eusales@silvaco.com

KOREA

krsales@silvaco.com

TAIWAN

twsales@silvaco.com

SINGAPORE

sgsales@silvaco.com



WWW.SILVACO.COM